

AA3528VR41S-W2-AMT

3.5 x 2.8 mm Surface Mount LED Lamp



DESCRIPTIONS

- The source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- Single color
- Suitable for all SMD assembly and solder process
- · Available on tape and reel
- · Ideal for backlighting
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · RoHS compliant

APPLICATIONS

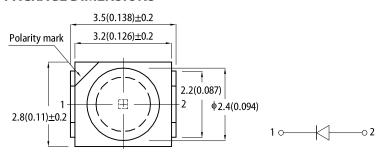
- Traffic signaling
- · Backlighting (illuminated advertising, general lighting)
- · Interior and exterior automotive lighting
- Substitution of micro incandescent lamps
- Reading lamps
- Signal and symbol luminaire for orientation
- Marker lights (e.g. Steps, exit ways, etc)
- · Decorative and entertainment lighting
- · Indoor and outdoor commercial and residential architectural lighting

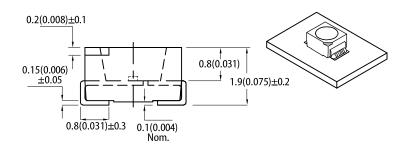
ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



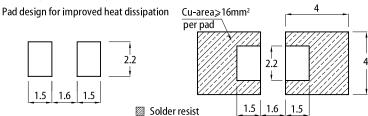
PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.1)



- 1. All dimensions are in millimeters (inches).
- Tolerance is ±0.25(0.01") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Dord Novelean	Emitting Color	Lawa Tama	Iv (mcd) @ 20mA [2]			Viewing Angle [1]	
Part Number	(Material)	Lens Type	Code.	Min.	Max.	201/2	
	Warm White (InGaN)	Yellow Fluorescent	U	1000	1300	120°	
AA3528VR41S-W2-AMT			V	1300	1600		
			W	1600	1900		

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value			Unit
Parameter	Symbol	Emitting Color	Min.	Тур.	Max.	Unit
Capacitance	С	Warm White	-	100	-	pF
Forward Voltage I _F = 20mA	V _F ^[1]	Warm White	-	3.3	4.0	V
Color Temperature	ССТ	Warm White	2870	3000	3220	К
Reverse Current (V _R = 5V)	I _R	Warm White	-	-	50	uA
Temperature Coefficient of x I_F = 20mA, -10°C \leq T \leq 100°C	TC _x	Warm White	-	-0.15	-	10 ⁻³ /°C
Temperature Coefficient of y $I_F = 20mA$, $-10^{\circ}C \le T \le 100^{\circ}C$	TC _y	Warm White	-	-0.16	-	10 ⁻³ /°C
Temperature Coefficient of V_F $I_F = 20mA, -10^{\circ}C \le T \le 100^{\circ}C$	TC _V	Warm White	-	-3.0	-	mV/°C

ABSOLUTE MAXIMUM RATINGS at T_A =25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	120	mW
Reverse Voltage	V _R	5	V
Junction Temperature	T _j	115	°C
Operating Temperature	T _{op}	-40 to +100	°C
Storage Temperature	T _{stg}	-40 to +110	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	I _{FM} ^[1]	100	mA
Electrostatic Discharge Threshold (HBM)	-	250	V
Thermal Resistance (Junction / Ambient)	R _{th JA} [2]	210	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	110	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{ih, M}$, $R_{ih, M}$, $R_{ih, M}$, $R_{ih, M}$ Results from mounting on PC board FR4 (pad size \geq 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

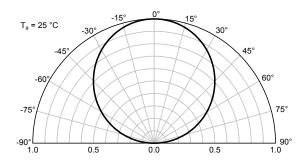


^{1.} Forward voltage: ±0.1V.
2. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

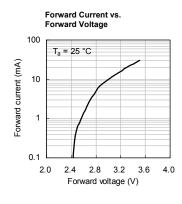


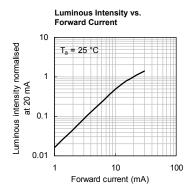
TECHNICAL DATA

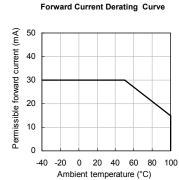
SPATIAL DISTRIBUTION

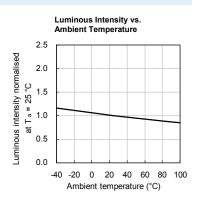


WARM WHITE

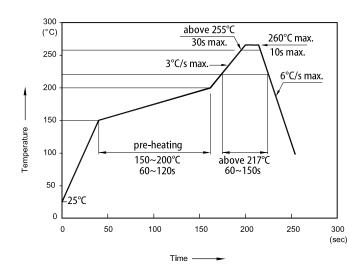








REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



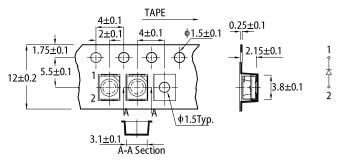
Notes:

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.

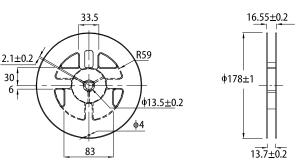
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units: mm)

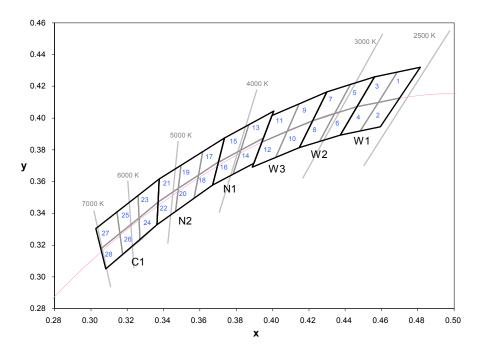


REEL DIMENSION (units: mm)





CIE CHROMATICITY DIAGRAM



Group	Chromaticity Pogions	CCT (K)			
Group Chromaticity Regions		Min.	Тур.	Max.	
W1	1, 2, 3, 4	2580	2700	2870	
W2	5, 6, 7, 8	2870	3000	3220	
W3	9, 10, 11, 12	3220	3500	3710	

Group	Chromaticity Regions	CCT (K)				
Croup	Officialities (Controlled	Min.	Тур.	Max.		
N1	13, 14, 15, 16	3710	4000	4260		
N2	17, 18, 19, 20, 21, 22	4260	4700	5310		
C1	23, 24, 25, 26, 27, 28	5310	6000	7040		

Notes: Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ±0.01.

	х	у		Х	У		X	у		x	у
	0.4582	0.4099		0.4147	0.3814		0.3702	0.3722		0.3481	0.3557
4	0.4687	0.4289	0	0.4221	0.3984	15	0.3736	0.3874	22	0.3370	0.3472
1	0.4813	0.4319	8	0.4342	0.4028	15	0.3869	0.3958		0.3364	0.3328
	0.4700	0.4126		0.4259	0.3853		0.3825	0.3798		0.3466	0.3411
	0.4483	0.3919		0.4080	0.3916		0.3670	0.3578		0.3376	0.3616
2	0.4582	0.4099	9	0.4146	0.4089	16	0.3702	0.3722	23	0.3260	0.3512
2	0.4700	0.4126	9	0.4299	0.4165	10	0.3825	0.3798	23	0.3265	0.3371
	0.4593	0.3944		0.4221	0.3984		0.3783	0.3646		0.3370	0.3472
	0.4465	0.4071		0.4017	0.3751		0.3736	0.3874		0.3370	0.3472
3	0.4562	0.4260	10	0.4080	0.3916	17	0.3616	0.3788	24	0.3265	0.3371
3	0.4687	0.4289	10	0.4221	0.3984	17	0.3592	0.3641	24	0.3270	0.3230
	0.4582	0.4099		0.4147	0.3814		0.3703	0.3726		0.3364	0.3328
	0.4373	0.3893		0.3941	0.3848		0.3703	0.3726		0.3260	0.3512
4	0.4465	0.4071	11	0.3996 0.4015 0.3592 0.364	0.3641	25	0.3144	0.3408			
4	0.4582	0.4099	11	0.4146	0.4089	18	0.3568	0.3495	25	0.3160	0.3274
	0.4483	0.3919		0.4080	0.3916		0.3670	0.3578		0.3265	0.3371
	0.4342	0.4028		0.3889	0.3690		0.3616	0.3788		0.3265	0.3371
5	0.4430	0.4212	12	0.3941	0.3848	19	0.3496	0.3702	26	0.3160	0.3274
5	0.4562	0.4260	12	0.4080	0.3916	19	0.3481	0.3557	20	0.3175	0.3139
	0.4465	0.4071		0.4017	0.3751		0.3592	0.3641		0.3270	0.3230
	0.4259	0.3853		0.3825	0.3798		0.3592	0.3641		0.3144	0.3408
0	0.4342	0.4028	40	0.3869	0.3958	20	0.3481	0.3557	27	0.3028	0.3304
6	0.4465	0.4071	13	0.4006	0.4044	20	0.3466	0.3411	21	0.3055	0.3177
	0.4373	0.3893		0.3950	0.3875		0.3568	0.3495		0.3160	0.3274
	0.4221	0.3984		0.3783	0.3646		0.3496	0.3702		0.3160	0.3274
7	0.4299	0.4165	14	0.3825	0.3798	21	0.3376	0.3616	28	0.3055	0.3177
7	0.4430	0.4212	14	0.3950	0.3875	21	0.3370	0.3472		0.3081	0.3049
	0.4342	0.4028		0.3898	0.3716		0.3481	0.3557		0.3175	0.3139



RELIABILITY TEST ITEMS AND CONDITIONS

The reliability of products shall be satisfied with items listed below

LOT TOLERANCE PERCENT DEFECTIVE (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	T _a = 25°C, I _F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	T _a = 100°C, I _F = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	T _a = -40°C, I _F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T _a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	T _a = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	-	T _a = 60°C, RH = 90%	500 h	0 / 22
7	High temp. & humidity operating test	-	$T_a = 60$ °C, RH = 90% $I_F = maximum rated current *$	500 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$T_a = -40$ °C(15min) ~ 100°C(15min) $I_F = $ derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	$T_a = -40$ °C(15min) ~ maximum rated storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	C = 100pF, R2 = 1.5KΩ V = 250V	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s², f = 100~2KHz, t = 48min for all xyz axes	4 times	0 / 22

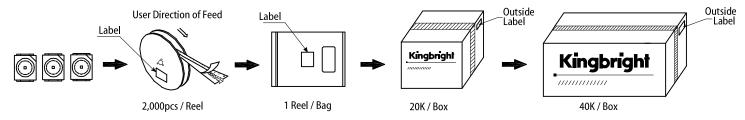
^{*:} Refer to forward current vs. derating curve diagram

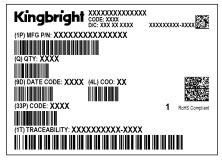
CRITERIA FOR JUDGING DAMAGE

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	I _V	I _F = 20mA	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	I _F = 20mA	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage	Testing Max. Value ≥ Spec. Max. Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking



PACKING & LABEL SPECIFICATIONS

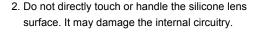




HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.









- 4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
- As silicone encapsulation is permeable to gases, some corrosive substances such as H₂S might corrode silver plating of lead frame. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.

 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

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